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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

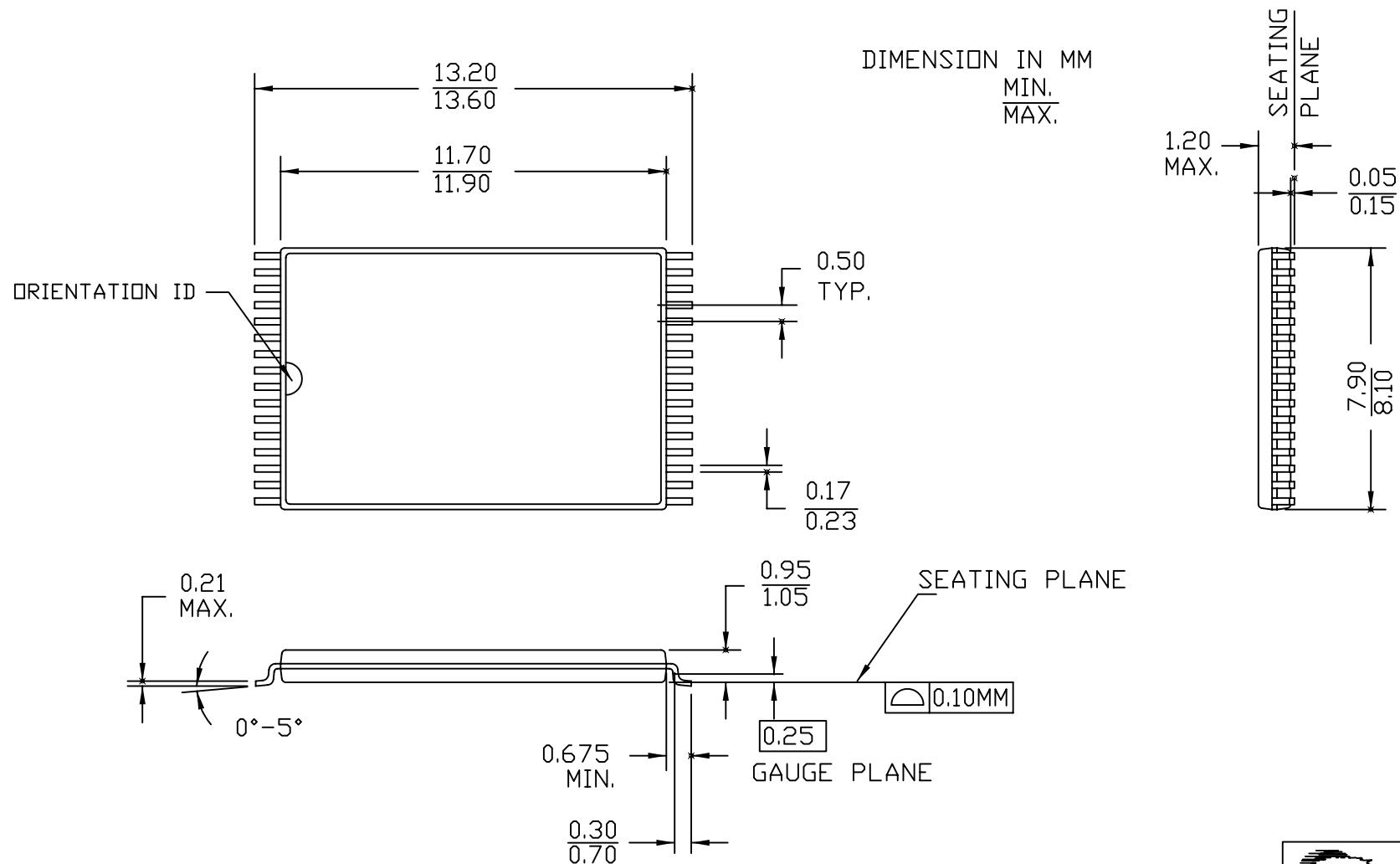
Continuity of document content

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

32 Lead TSOP 8 X 13.4 mm STANDARD



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PACKAGE
CODE(S)

ZA32



CYPRESS
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TITLE
PACKAGE OUTLINE, 32LD SMALL TSOP 8X13.4X1.2
MM ZA32

SPEC NO.
51-85094

REV
#G

SCALED TO FIT

N/A

SHEET 1 OF 2

Rev.	ECN No.	Origin of Change	Description of Change
**	50588		NEW RELEASE
*A	58835		CHG. LEAD THICKNESS DIM.
*B	66396		REMOVE THE INCH UNIT ON DIMENSIONS
*C	102262		REMOVE PIN NUMBERS
*D	103908		CHG. PIN 1 ORIENTATION TO ORIENTATION ID
*E	2866234		Changed Template and Title from 32LD SMALL TSOP PKG. OUTL. to PACKAGE OUTLINE, 32LD SMALL TSOP 8X13.4X1.2 MM ZA32.
*F	3159033		NO CHANGE
*G	4279842	KTQAD/ ROWI	SUNSET REVIEW. CHANGED DRAWING TEMPLATE.



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PACKAGE OUTLINE, 32LD SMALL TSOP 8X13.4X1.2
MM ZA32

SPEC NO. 51-85094 REV #G

SCALED TO FIT N/A SHEET 2 OF 2

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